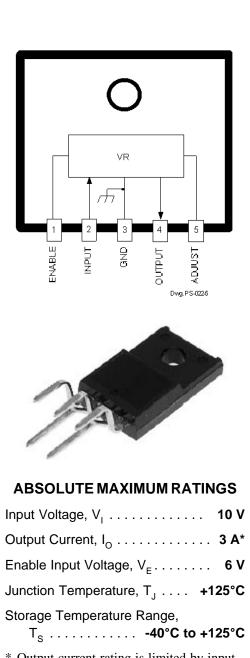


SI-3011ZF

High-Current, Low-Dropout, 1.1~5 V Regulator



* Output current rating is limited by input voltage, duty cycle, and ambient temperature. Under any set of conditions, do not exceed a junction temperature of +125°C. Designed to meet the high-current requirements in industrial and consumer applications; embedded core, memory, or logic supplies; TVs, VCRs, and office equipment, the SI-3011ZF voltage regulator offers the reduced dropout voltage and low quiescent current essential for improved efficiency. This device delivers a regulated output at up to 3 A. Integrated thermal and overcurrent protection enhance overall system reliability. Devices with fixed output voltages of 2.5 V or 3.3 V are also available.

Quiescent current does not increase significantly as the dropout voltage is approached, an ideal feature in standby/resume power systems where data integrity is crucial. Regulator accuracy and excellent temperature characteristics are provided by a bandgap reference. An LS-TTL/CMOS-compatible input gives the designer complete control over power up, standby, or power down. A pnp pass element provides a dropout voltage of less than 700 mV at 3 A of load current. Low output voltages eliminate the need for expensive PWM buck converters. The low dropout voltage permits more efficient regulation before output regulation is lost.

This device is supplied in a fully molded TO-220-style 5-lead flange-mounted, high power, isolated plastic package. A similar device in a lower-power surface-mount plastic package is the SI-3011ZD.

FEATURES

- 3 A Output Current
- 0.7 V Maximum Dropout Voltage at $I_0 = 3 A$
- 1 µA Maximum Standby Current
- Adjustable 1.1 ~ 5 V Output Voltage
- Remote Voltage Sensing
- Foldback Current Limiting
- Thermal Protection

APPLICATIONS

- TVs, VCRs, Electronic Games
- Embedded Core, Memory, or Logic Supplies
- Printers and Other Office Equipment
- Industrial Machinery
- Secondary-Side Stabilization of Multi-Output SMPS

Always order by complete part number, e.g., SI-3011ZF .



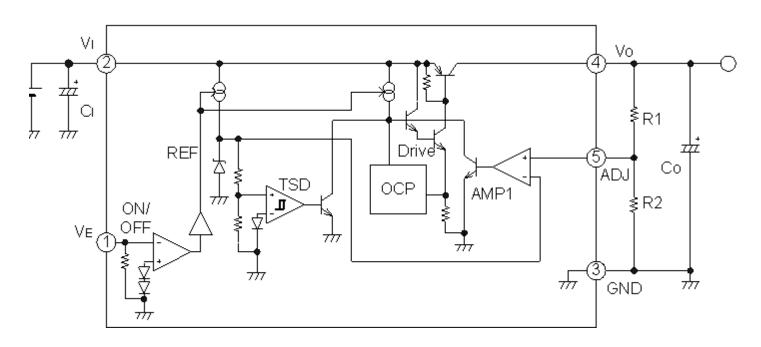
Sanken Power Devices from Allegro MicroSystems



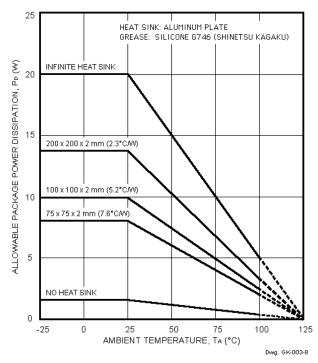
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FUNCTIONAL BLOCK DIAGRAM



Allowable Package Power Dissipation



Recommended Operating Conditions

	Min	Мах	Units
DC Input Voltage	—	6	V
DC Output Current	0	3	А
Adjustable Voltage Range	1.2	5	V
Operating Junction Temp.	-20	+100	°C

For the availability of parts meeting -40°C requirements, contact Allegro's Sales Representative.

This data sheet is based on Sanken data sheet SSJ-02605



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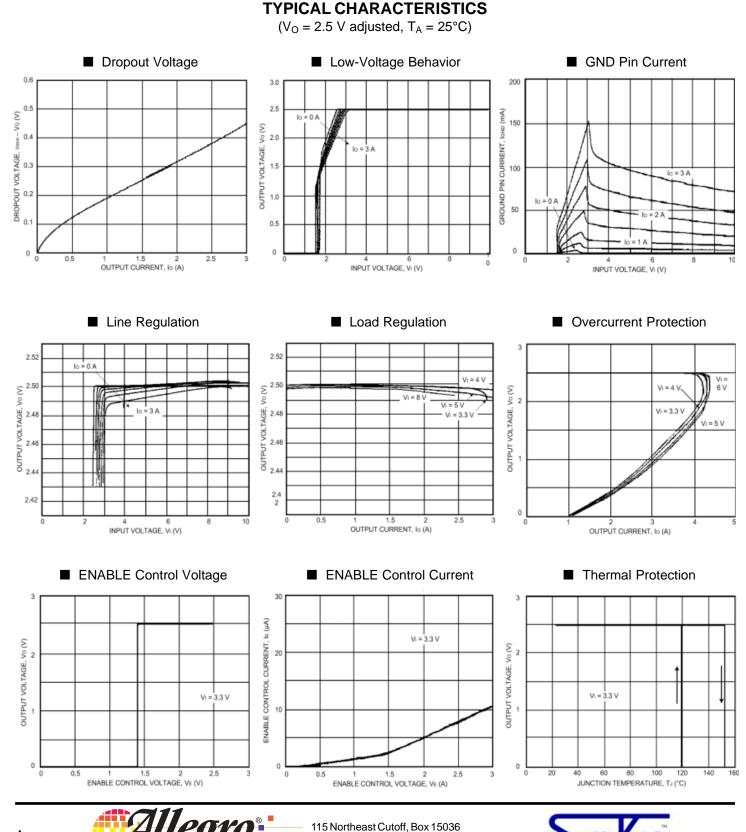
ELECTRICAL CHARACTERISTICS at $T_A = +25$ °C, $V_O = 2.5$ V adjusted, $V_E = 2$ V (unless otherwise noted).

			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Output Voltage	Vo	$V_{I} = V_{O(nom)} + 1 V, I_{O} = 10 mA$		V _{O(nom)}		V
	V _{O(off)}	$V_{E} = 0 V$	-	—	0.5	V
Output Volt. Temp. Coeff.	a _{vo}	$0^{\circ}C \leq T_{J} \leq 100^{\circ}C$		±0.3		mV/°C
Internal Reference Voltage	V _{ref}	$V_{I} = V_{O(nom)} + 1 V, I_{O} = 10 mA$	1.078	1.100	1.122	V
Output Short-Circuit Current	I _{OM}	$V_{I} = V_{O(nom)} + 1 V$, see note	3.2			А
Line Regulation	$\Delta V_{O(\Delta VI)}$	$V_1 = 3.0 \sim 5.0 \text{ V}, \text{ I}_0 = 10 \text{ mA}$			10	mV
Load Regulation	$\Delta V_{O(\Delta IO)}$	$V_{I} = 3.3 \text{ V}, I_{O} = 0 \text{ A} \sim 3.0 \text{ A}$			40	mV
Dropout Voltage	V _{Imin} - V _O	I _O = 3.0 A			0.7	V
Ground Terminal Current	I _{GND}	$V_{I} = V_{O(nom)} + 1 \text{ V}, I_{O} = 0 \text{ mA}, V_{E} = 2.0 \text{ V}$		1.0	1.5	mA
		$V_{I} = V_{O(nom)} + 1 V, V_{E} = 0 V$		—	1.0	μA
Enable Input Voltage	V _{EH}	Output ON	2.0			V
	V _{EL}	Output OFF			0.8	V
Enable Input Current	I _{EH}	V _E = 2.7 V	-	_	100	μA
	I _{EL}	$V_{E} = 0 V$		0	-5.0	μA
Ripple Rejection Ratio	PSRR	$V_{I} = V_{O(nom)}$ + 1 V, 100 Hz \leq f \leq 120 Hz		60		dB
Thermal Shutdown	Τ _J		135	152	_	°C

Typical values are given for circuit design information only.

Note: Output short-circuit current is at point where output voltage has decreased 5% below $V_{O(nom)}$.





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SanKen

4

Linear Drs

APPLICATIONS INFORMATION

Input Capacitor (C_I , approximately 10 μ F). This is necessary either when the input line includes inductance or when the wiring is long.

Output Capacitor (C_0 , > 47 μ F). This device is not designed for a use with a very low ESR output capacitor such as a ceramic capacitor. Output oscillation may occur with that kind of capacitor.

Output Voltage Adjustable Resistors (R1 and R2). The output voltage is adjusted by R1 and R2. 10 k Ω or 11 k Ω for R2 is recommended.

$$R1 = (V_O - V_{ref})/(V_{ref}/R2)$$

For an output voltage of 1.8 V or less, add a 10 k Ω resistor between ADJ and the junction of R1 and R2.

Determination of DC Input Voltage. The minimum input voltage $V_I(min)$ should be higher than the sum of the fixed output voltage and the maximum rated dropout voltage. If setting the output voltage lower than 2.0 V, the minimum input voltage should be more than 2.4 V.

Overcurrent Protection. The SI-3000ZD series has a built-in fold-back type overcurrent protection circuit, which limits the output current at a start-up mode. It thus cannot be used in applications that require current at the start-up mode such as:

(1) constant-current load,

(2) power supply with positive and negative outputs to common load (a center-tap type power supply), or(3) raising the output voltage by putting a diode or a resistor between the device ground and system ground.

Thermal Protection. Circuitry turns off the pass transistor when the junction temperature rises above 135°C. It is intended only to protect the device from failures due to excessive junction temperatures and should not imply that output short circuits or continuous overloads are permitted.

Heat Radiation and Reliability. The reliability of the IC is directly related to the junction temperature (T_J) in its operation. Accordingly, careful consideration should be given to heat dissipation. The graph on page 2 illustrates the effect of thermal resistance on the allowable package power dissipation.

When mounting to a heat sink, apply silicone grease (Shin-Etsu Chemical G746, Dow Corning Toray Silicone SC102, or Toshiba Silicone SY6260). Recommended mounting hardware torque: $0.588 \sim 0.686$ Nm or $6.0 \sim 7.0$ kgf•cm ($4.34 \sim 5.06$ lbf•ft).

The junction temperature (T_J) can be determined from either of the following equations:

 $T_{J} = (P_{D} \times R_{\theta JA}) + T_{A}$

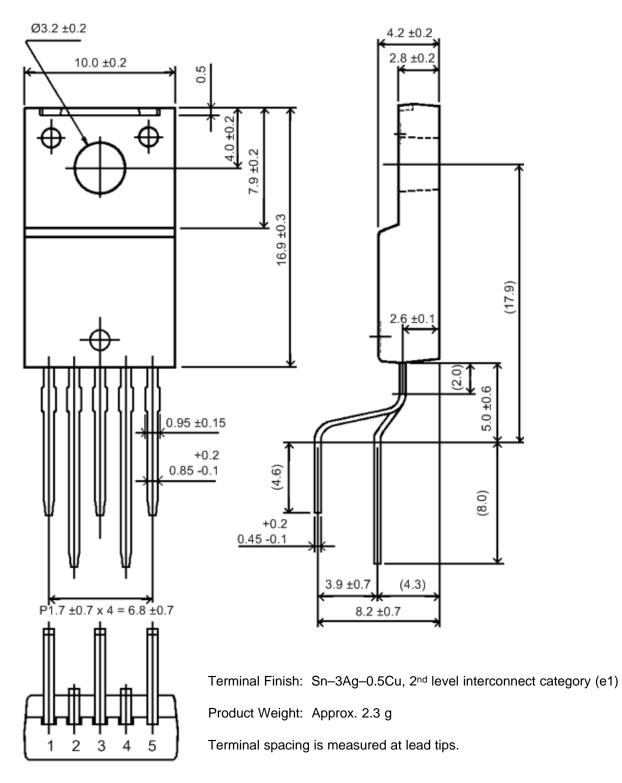
or

$$\begin{split} T_{J} &= (P_{D} \times R_{\theta JC}) + T_{C} \\ \text{where} \ \ P_{D} &= I_{O} \times (V_{I} - V_{O}) \text{ and} \\ R_{\theta JC} &= 5^{\circ} C/W. \end{split}$$

Parallel Operation. Parallel operation to increase load current is not permitted.



Dimensions in Millimeters



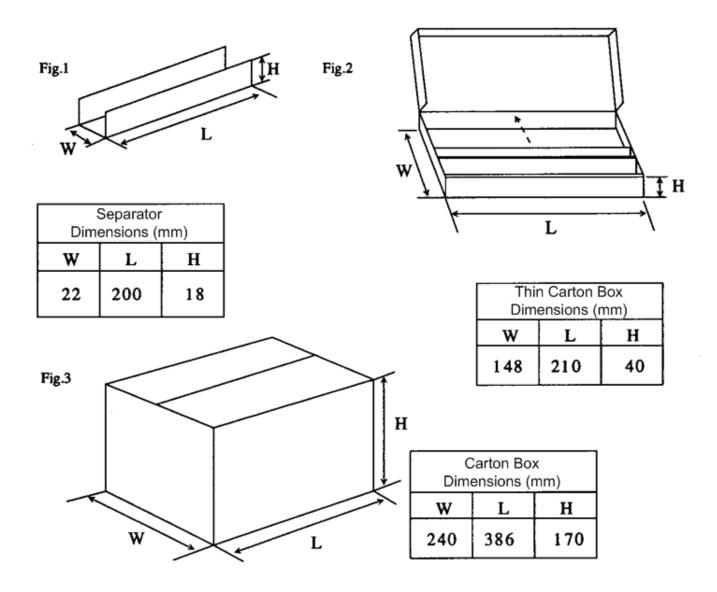


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Shipping Container Dimensions in Millimeters



Primary Packing: A U-shaped cardboard separator (Fig. 1) is used to accommodate a maximum of 100 pieces (5×20) and, if less than 100 pieces, a shock absorber shall be placed in the vacant space. Each thin primary carton (Fig. 2) will contain a maximum of 400 pieces in four rows.

Secondary Packing: The secondary carton (Fig. 3) contains nine thin cartons.



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When using the products described herein, the applicability and suitability of such products for the intended purpose shall be reviewed at the users responsibility.

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Users of Sanken products are requested to take, at their own risk, preventative measures including safety design of the equipment or systems against any possible injury, death, fires or damages to society due to device failure or malfunction.

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When considering the use of Sanken products in applications where higher reliability is required (transportation equipment and its control systems or equipment, fire- or burglar-alarm systems, various safety devices, etc.), contact a company sales representative to discuss and obtain written confirmation of your specifications.

The use of Sanken products without the written consent of Sanken in applications where extremely high reliability is required (aerospace equipment, nuclear power-control stations, life-support systems, etc.) is strictly prohibited.

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